

Surface Mount Glass Passivated Fast Recovery Rectifier Reverse Voltage 50~1000V Forward Current 1A

Features

- · Glass passivated fast recovery rectifiers
- Heatsink structure
- · Low profile, typical thickness 0.8mm
- · Low forward voltage drop
- · Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s



iSGA (SOD-123HS)

Typical Applications

For use of general purpose rectification in lighting, cellular phone, portable device, power supplies, and other consumer applications.

Maximum Ratings (TA = 25 °C unless otherwise noted)									
Parameter	Symbol	PF1	PF2	PF3	PF4	PF5	PF6	PF7	Unit
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	800	1000	٧
Maximum RMS voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	IF(AV)	1.0						Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	IFSM	30						Α	
Rating for fusing(t<8.3ms)	l ² t	3.8						A ² sec	
Operating junction and storage temperature range	TJ, TSTG	- 55 to + 150					°C		

Electrical Characteristics (TA = 25 °C unless otherwise noted)										
Parameter	Test Conditions	Symbol	PF1	PF2	PF3	PF4	PF5	PF6	PF7	Unit
Minimum Breakdown voltage	Ta=25°C,IR=100uA	V_{BR}	400		600 1000		00			
Maximum instantaneous	IF=1 A,Ta=25℃	V _F	1.3						V	
forward voltage	IF=1 A,Ta=125℃	VF	0.98							
Maximum DC reverse current	TA=25°C	I-	5.0						μА	
at rated DC blocking voltage	TA=125°C	I _R	50							
Maximum reverse recovery	I _F =0.5A,I _R =1.0A,	+	150 250						nS	
time	I _{rr} =0.25A	t _{rr}	150				250			113
Typical junction capacitance	4.0 V, 1 MHz	CJ	7.5				pF			
	juntion to ambient	R _{0JA} 1)	63							
Typical thermal resistance	juntion to lead	R _{0JL} 1)	9						°C/W	
	juntion to case	R _{θJC} ²⁾	39							

Note:1), The thermal resistance from junction to ambient or lead, mounted on P.C.B with 5x5mm copper pads, 2 OZ, FR4 PCB

2), The thermal resistance from junction to case, mounted on P.C.B with recommended copper pads, 2 OZ, FR4 PCB

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Ratings and Characteristics Curves

(TA = 25° C unless otherwise noted)

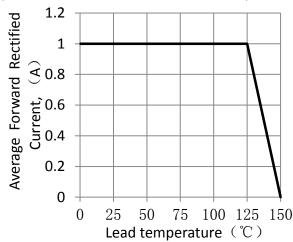


Figure 1. Forward Current Derating Curve

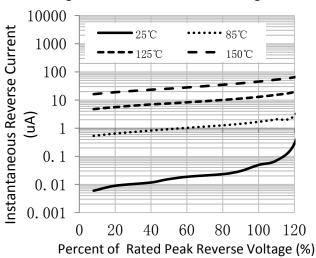


Figure 3. Typical Reverse Characteristics

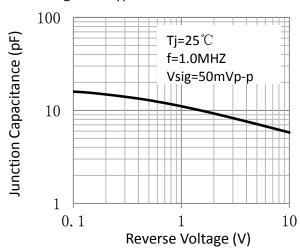


Figure 5. Typical Junction Capacitance

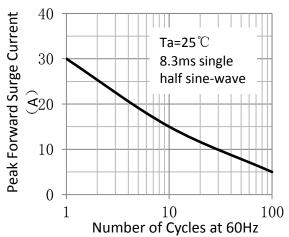
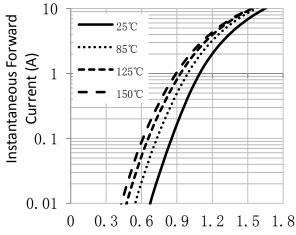


Figure 2.Maximum Non-Repetitive Peak Forward Surge Current

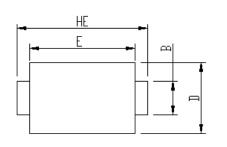


Instantaneous Forward Voltage (V)

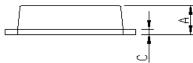
Figure 4. Typical Instantaneous Forward Characteristics

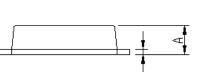
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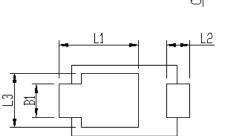
Package Outline Dimensions





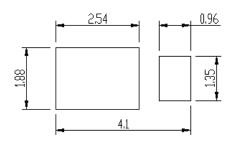






Package	iSGA				
Unit:mm	MIN	MAX			
Α	0.75	0.90			
В	0.85	1.05			
B1	0.85	1.05			
С	0.1	0.25			
D	1.9	2.1			
E	2.9	3.1			
L1	2.0	2.45			
L2	0.4	0.85			
L3	1.3	1.7			
HE	3.5	3.9			

Soldering footprint

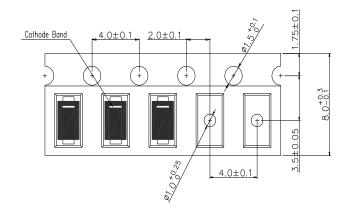


Packing Information

Packing quantities:

Reel size	Quantity/reel	ty/reel Quantity/inner Box Quantity			
7"	3K	30K	120K		

Packing Tape Specification





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